Overview

HP 240 G8 Notebook PC



- 1. Webcam LED
- 2. Webcam
- 3. Internal dual digital microphone
- 4. Touchpad
- 5. Touchpad buttons
- 6. Power indicator LED

- 7. Hard drive indicator LED
- 8. SD Card slot

Left

- 9. USB-C® 3.2 Gen1 port (Data Transfer Only)
- 10. Nano Security lock slot (Lock sold separately)
- 11. Power button

Overview



Right

- 1. AC Smart Pin adapter plug
- 2. RJ-45 / Ethernet port
- 3. HDMI port (Cable not included)

- 4. USB-A 3.2 Gen 1 port
- 5. USB-A 3.2 Gen 1 port
- 6. Audio combo jack

Overview

At a Glance

- A new compact narrow bezel design with thinner & lighter chassis
- Preinstall with Windows 10 versions or FreeDOS
- Choice of 10th Generation Intel® CoreTM i7, i5 and i3 processors and Intel® Pentium®, or Intel® Celeron® processors
- Choice of 35.56 cm (14") diagonal HD Anti-Glare WLED SVA or FHD Anti-Glare WLED IPS
- Choice of Integrated Intel® Iris® Plus graphics, UHD Graphics 620/605/600 or Switchable Discrete Graphics AMD RadeonTM 620
- Security features including Firmware TPM 2.0
- Weight starting at 3.25 lbs (1.47 kgs)
- MM18 Battery life Up to 9 Hours 25 mins up to 8 hours 1
- Wireless LAN (WLAN) up to 802.11ac or 802.11ax to keep you connected
- One USB 3.2 Gen 1 Type-C[®] (Data Transfer Only), Two USB 3.2 Gen 1 Type-A
- Choice of Solid State Drives up to 1 TB and Hard Drive up to 1 TB
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 16 GB
- HP webcam with dual digital microphone and HD (supporting WDR- Wide Dynamic Range) or VGA camera

1. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.

NOTE: See important legal disclosures for all listed specs in their respective feature sections.



PRODUCT NAME

HP 240 G8 Notebook PC

OPERATING SYSTEMS

Preinstalled Windows 10 Pro 64 - HP recommends Windows 10 Pro¹

Windows 10 Pro 64 (National Academic only) 2

Windows 10 Home 64 1

Windows 10 Home Single Language 64 1

FreeDOS

- 1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchase hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.
- 2. Some devices for academic use will automatically be updated to Windows 10 Pro Education with the Windows 10 Anniversary Update. Features vary; see https://aka.ms/ProEducation for Windows 10 Pro Education feature information.

Supported Version

HP tested Windows 10, version 1809 on this platform For testing information on newer versions of Windows 10, please see: https://support.hp.com/document/c05195282.

PROCESSORS

Intel® CoreTM i7-1065G7 with Intel® Iris® Plus graphics (1.3 GHz base frequency, up to 3.9 GHz with Intel® Turbo Boost Technology 8 MB cache, 4 cores) ^{3,4,5,6}

Intel® CoreTM i5-1035G1 processor with Intel® UHD Graphics (1.0 GHz base frequency, up to 3.6 GHz with Intel® Turbo Boost Technology, 6 MB cache, 4 cores) ^{3,4,5,6}

Intel® CoreTM i3-1005G1 processor with Intel® UHD Graphics (1.2 GHz base frequency, up to 3.4GHz with Intel® Turbo Boost Technology, 4 MB cache, 2 cores) ^{3,4,5,6}

Intel® Pentium® Silver N5030 Processor with Intel® UHD Graphics 605 (1.1 GHz base frequency, up to 3.1 GHz burst frequency, 4 MB cache, 4 cores) ^{3,4,6}

Intel® Celeron® N4020 Processor with Intel® UHD Graphics 600 (1.1 GHz base frequency, up to 2.8 GHz burst frequency, 4 MB cache. 2 cores) ^{3,4,6}

Intel® Pentium® Gold 6805 Processor with Intel® UHD Graphics (1.10 GHz base frequency, up to 3.00 GHz Standard, 4 MB cache, 2 cores) ^{3,4,6}

Processors Family

10th Generation Intel® CoreTM i7 processor (i7-1065G7) ⁶
10th Generation Intel® CoreTM i5 processor (i5-1035G1) ⁶
10th Generation Intel® CoreTM i3 processor (i5-1005G1) ⁶
Intel® Pentium® Silver Processor (N5030) ⁶
Intel® Pentium® Gold Processor (6805) ⁶
Intel® Celeron® processor (N4020) ⁶

3. Multicore is designed to improve performance of certain software products. Not all customers or software applications will

Technical Specifications

necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. Intel's numbering, branding and/or naming is not a measurement of higher performance.

- 4. Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode. 5. Intel® Turbo Boost performance varies depending on hardware, software and overall system configuration. See http://www.intel.com/technology/turboboost for more information.
- 6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on product configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.

CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

Intel® Iris® Plus graphics Intel® UHD Graphics Intel® UHD Graphics 605 Intel® UHD Graphics 600

Discrete

AMD RadeonTM 620 (2 GB GDDR5 dedicated) 8

Supports

Support HD decode, DX12, HDMI 1.4b ⁷

- 7. HD content required to view HD images.
- 8. AMD Dynamic Switchable Graphics technology requires an Intel processor, plus an AMD RadeonTM discrete graphics configuration and is not available on FreeDOS and Linux OS. With AMD Dynamic Switchable Graphics technology, full enablement of all discrete graphics video and display features may not be supported on all systems (e.g. OpenGL applications will run on the integrated GPU or the APU as the case may be).

DISPLAYS

Internal

Non-Touch

35.56 cm (14") diagonal, HD (1366 x 768), SVA, Anti-Glare WLED, 250nits, eDP micro-edge, 45% NTSC ^{7,9,10} 35.56 cm (14") diagonal, FHD (1920 x 1080), IPS, Anti-Glare WLED, 250nits eDP micro-edge, 45% NTSC ^{7,9,10}

HDMI

Port supports resolutions up to 1920 x 1080 external resolution @60 Hz

- 7. HD content required to view HD images.
- 9. Sold separately or as an optional feature.
- 10. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

STORAGE AND DRIVES

Primary Storage

1 TB 5400 rpm SATA ¹¹ 500 GB 7200 rpm SATA ¹¹ 500 GB 5400 rpm SATA ¹¹

Primary M.2 Storage

128 GB M.2 SATA-3 TLC Solid State Drive ¹¹
256 GB M.2 SATA-3 TLC Solid State Drive ¹¹
256 GB PCIe® NVMeTM M.2 Value Solid State Drive ¹¹
512 GB PCIe® NVMeTM M.2 Value Solid State Drive ¹¹
1 TB PCIe® NVMeTM M.2 Value Solid State Drive ¹¹
256 GB Intel® PCIe® NVMeTM QLC M.2 SSD with 16 GB Intel® OptaneTM memory H10 ^{11,12,13}
512 GB Intel® PCIe® NVMeTM QLC M.2 SSD with 32 GB Intel® OptaneTM memory H10 ^{11,12,13}
64 GB eMMC ¹¹

Dual Storage

128 GB M.2 SATA-3 TLC Solid State Drive + 1TB 5400rpm SATA ¹¹
256 GB PCIe® NVMeTM M.2 Value Solid State Drive + 1TB 5400rpm SATA ¹¹

- 11. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) i reserved for system recovery software.
- 12. Intel® OptaneTM memory system acceleration does not replace or increase the DRAM in your system. Requires 8th Gen or higher Intel® CoreTM processor, BIOS version with Intel® OptaneTM supported, Windows 10 64-bit, and an Intel® Rapid Storage Technology (Intel® RST) driver.
- 13. Intel® OptaneTM memory H10 only for Intel® PCIe® NVMeTM QLC M.2 SSD.

MEMORY

Maximum Memory

16 GB DDR4-2666 SDRAM14

Memory

16 GB DDR4-2666 SDRAM (2 X 8 GB) ¹⁴
12 GB DDR4-2666 SDRAM (4 GB (1 x 4GB) and 8 GB (1 x 8 GB)) ¹⁴
8 GB DDR4-2666 SDRAM (1 x 8 GB) ¹⁴
8 GB DDR4-2400 SDRAM (1 x 8 GB) ¹⁴
8 GB DDR4-2666 SDRAM (2 x 4 GB) ¹⁴
4 GB DDR4-2666 SDRAM (1 x 4 GB) ¹⁴
4 GB DDR4-2400 SDRAM (1 x 4 GB) ¹⁴

Memory Slots

2 SODIMM (10th Generation Intel® CoreTM)
All slots are customer non-accessible / non-upgradeable
Supports Dual Channel Memory
1 SODIMM (Intel® Pentium®, Celeron® processors)

NOTE: All slots are customer non-accessible / non-upgradeable

14. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.



NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8822CE 802.11ac 2x2 Wi-Fi® + Bluetooth® 5 ²⁹
Realtek RTL8822CE 802.11a/b/g/n/ac (1x1) Wi-Fi® with Bluetooth® 4.2 Combo ²⁹
Intel® Dual Band Wi-Fi 6 AX201 802.11a/b/g/n/ac/ax (2x2) WLAN and Bluetooth® 5 Combo, non-vPro® ¹⁵

Miracast

Compatible with Miracast-certified devices (For Win10) 16

Ethernet

Realtek 10/100/1000 GbE NIC 17

15. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If th final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.

16. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.

17. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

29. Wi-Fi supporting gigabit speeds (802.11ac) is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160MHz channels.

AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Integrated dual digital microphone

Camera

HP TrueVision HD Camera 7,9

Webcam

VGA webcam 9

- 7. HD content required to view HD images.
- 9. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS



Keyboard

Full Size Textured island-style Keyboard

Pointing Device

Touchpad with multi-touch gesture support (PTP certified)

Function Keys

F1 - Open " How to get help in Windows 10" webpage

F2 - Brightness Down

F3 - Brightness Up

F4 - Display Switching

F5 - Blank

F6 - Mute

F7 - Volume Down

F8 -Volume Up

F9 - Previous

F10 - Play/Pause

F11 - Next

F12 - Airplane mode

SOFTWARE AND SECURITY

Preinstalled Software

Software

McAfee LiveSafeTM 18

HP Support Assistant 19

Native Miracast Support 20

HP documentation

HP Setup Integrated 00BE

HP SSRM

HP Audio Switch

HP JumpStarts

Xerox® DocuShare® 90 day free trial offer²⁸

Security Management

Firmware TPM 2.0 ²¹

- 18. 30 days free trial.
- 19. HP Support Assistant requires Windows and Internet access.
- 20. Miracast is a wireless technology your PC can use to project your screen to TVs, projectors, and streaming.
- 21. Firmware TPM is version 2.0. which is a subset of the TPM 2.0 specification version v0.89 as implemented by Intel Platform Trust Technology (PTT).32. Firmware TPM is version 2.0.
- 28. Simply sign up and start using Xerox® DocuShare® Go. No credit card. No obligation. Data will become unavailable unless a subscription is entered before the end of the 90 day free trial period. See visit www.xerox.com/docusharego for details.

POWER



Power Supply

HP Smart 65 W External AC power adapter ²² HP Smart 65 W EM External AC power adapter ²² HP Smart 45 W External AC power adapter ²²

Primary Battery

HP Long Life 3-cell, 41 Wh Li-ion ²³ HP Long Life 4-cell, 46 Wh Li-ion Battery (India only) ²³

Power Cord

1M (3.28 feet) length power cord

MM18 Battery life

Up to 9 Hours 25 mins Battery life
Up to 8 hours 24

Battery Weight

0.18 kg 0.39 lb

- 22. Availability may vary by country.
- 23. Battery is internal and not replaceable by customer. Serviceable by warranty.
- 24. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

WEIGHTS & DIMENSIONS

Product Weight ²⁵

Starting at 3.25 lb Starting at 1.47 kg

Product Dimensions (w x d x h)

12.76 x 8.89 x 0.78 in 32.4 x 22.59 x 1.99 cm

25. Weight will vary by configuration.

PORTS/SLOTS



Ports

2 USB-A 3.2 Gen1

1 USB Type-C[®] 3.2 Gen1 (Data Transfer Only)(Data Transferring only)

1 HDMI v1.4b ²⁶

1 RJ-45

1 AC Power

1 Headphone/microphone combo jack

Expansion Slots

SUDDORT SD/SDHC/SDXC

1 Multi-format digital media reader

26. HDMI cable sold separately.

SERVICE AND SUPPORT

1-year limited warranty and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service an extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.27

27. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicate to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and suc rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.

SYSTEM UNIT

Stand-Alone Power Requirements (AC

Power)

Nominal Operating Voltage 19.5 V Average Operating Power TBD Integrated graphics 6.37W

Discrete Graphics N/A (Switchable graphics design)

Max Operating Power Discrete < 65W UMA < 45W

Temperature

Operating 32° to 95° F (0° to 35° C) (not writing optical) 41° to 95° F (5° to 35° C) (writing optical)

Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity

Operating 10% to 90%, non-condensing

Non-operating 5% to 95%

Shock

Technical Specifications

Operating 40 G, 2 ms, half-sine Non-operating 240 G, 2 ms, half-sine

Random Vibration

Operating 1.043 grms Non-operating 3.5 grms

Altitude (unpressurized)

Operating -15 m to 3048 m (-50 ft to 10000 ft) Non-operating -15 m to 12192 m (-50 ft to 40000 ft)

Planned Industry Standard Certifications

UL	Yes
CSA	No
FCC Compliance	Yes
ENERGY STAR®	Yes
EPEAT®	Yes
ICES	Yes
Australia /	No
NZ A - Tick Compliance	No
CCC	Yes
Japan VCCI Compliance	No
KC	No
BSMI	Yes
CE Marketing Compliance	Yes
BNCI or BELUS	No
CIT	No
GOST	No
Saudi Arabian Compliance (ICCP)	No
SABS	No
UKRSERTCOMPUTER	No

DISPLAYS

Note: All specifications represent the typical specifications provided by HP's component manufacturers; actual performance may vary either higher or lower.

Technical Specifications

Panel LCD 14-in FHD (1920x1080) Anti-Glare WLED UWVA 45percent cg 250nits eDP NWBZ slim Outline Dimensions (W x H x D) 316.11 x 198.07 max. (w/ PCB)(mm)

Active Area 309.31 x 173.99(mm)

Weight 285g max.

Diagonal Size 14.0"

Thickness 3.0mm max.

Interface eDP 1.2

Surface Treatment Anti-glare (AG)

Touch Enabled None
Contrast Ratio 600:1 (typ)
Refresh Rate 60Hz
Brightness 250nit typ.

Pixel Resolution 1920 x 1080 (FHD)

Format RGB
Backlight LED
Color Gamut Coverage 45%
Color Depth 6bit

Viewing Angle UWVA 85/85/85

Panel LCD 14.0 HD AG WLED SVA 45%cg 220nits eDP Slim

 Outline Dimensions (W x H x D)
 320.9x205.6 (max)

 Active Area
 309.4 x 173.95

 Weight
 280 max.

 Diagonal Size
 14.0"

 Thickness
 3.0mm max

Interface VESA with EDID V3.1
Surface Treatment Anti-glare (AG)

Touch EnabledNoneContrast Ratio300:1 (typ)Refresh Rate60HzBrightness220 nit typPixel Resolution1366 x 768 (HD)

Format RGB
Backlight LED
Color Gamut Coverage 45%
Color Depth 6 bits

Viewing Angle SVA 40/40/15/30

STORAGE AND DRIVES*

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30 GB (for Windows 10) is reserved for system recovery software.

Technical Specifications

SSD 128GB 2280 M2 SATA-3 TLC (SSD 128GB 2280 M2 SATA-3 TLC)

Drive Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 128 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 ATA-8, SATA 3.0

Performance

Maximum Sequential ReadUp To 560 MB/sMaximum Sequential WriteUp To 530 MB/sLogical Blocks250,069,680

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

SSD 1TB 2280 PCIe NVMe Value (SSD 1TB 2280 PCIe NVMe Value) **Drive Weight** 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 1 TB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

Performance

Maximum Sequential ReadUp to 2400MB/sMaximum Sequential WriteUp to 1950MB/sLogical Blocks2,000,409,264

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

SSD 256GB 2280 M2 SATA-3 TLC (SSD 256GB 2280 M2 SATA-3 Three Layer Cell)

Drive Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X4

Performance

Maximum Sequential ReadUp to 530MB/sMaximum Sequential WriteUp to 520MB/sLogical Blocks500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Technical Specifications

SSD 256GB 2280 PCIe NVMe Value (SSD 256GB 2280 PCIe

NVMe Value)

Drive Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 256GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X2

Performance

Maximum Sequential ReadUp to 1500MB/sMaximum Sequential WriteUp to 750MB/sLogical Blocks500.118.192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM, L1.2

Drive Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

apacity 512GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X2

Performance

Maximum Sequential ReadUp to 1500MB/sMaximum Sequential WriteUp to 750MB/sLogical Blocks1,000,215,216

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Features TRIM, L1.2

SSD 16GB 2280 PCIe-3x2 NVMe 3D Xpoint (SSD 16GB 2280 PCIe-3x2 NVMe 3D Xpoint) **Drive Weight** 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 16 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X2

Performance

Maximum Sequential ReadUp to 900MB/sMaximum Sequential WriteUp to 145MB/sLogical Blocks28,181,188

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

Technical Specifications

SSD 256GB 2280 PCIe-3x2x2 Drive Weight NVMe+SSD 16GB 3D Capacity

Xpoint (SSD 256GB 2280 PCIe-3x2x2 NVMe +SSD 16GB

3D Xpoint)

ve Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 256 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X2X2

Performance

Maximum Sequential ReadUp to 1450MB/sMaximum Sequential WriteUp to 500MB/sLogical Blocks500,118,192

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

SSD 512GB 2280 PCIe-3x2x2 Drive Weight NVMe+SSD 32GB 3D Capacity

NVME+55D 32GB 3D Xpoint (SSD 512GB 2280 PCIe-3x2x2 NVMe +SSD 32GB

3D Xpoint)

rive Weight 0.01 lb (6 g) ~ 0.02 lb (10 g)

Capacity 512 GB

 Height
 0.09 in (2.3 mm)

 Width
 0.87 in (22 mm)

 Interface
 PCIe NVMe Gen3X2X2

Performance

Maximum Sequential ReadUp to 2400MB/sMaximum Sequential WriteUp to 1300MB/sLogical Blocks1,000,215,215

Operating Temperature 32° to 158°F (0° to 70°C) [ambient temp]

NETWORKING/COMMUNICATIONS

Intel® Wi-Fi 6 AX201 + Bluetooth® 5 (802.11ax 2x2, non-vPro®, supporting gigabit file transfer speeds) non-vPro®1,2 **Wireless LAN Standards**

IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11ax
IEEE 802.11d
IEEE 802.11b
IEEE 802.11e

IEEE 802.11k IEEE 802.11r IEEE 802.11v

Interoperability Frequency Band Features Wi-Fi® 6 technology

802.11b/g/n/ax

2.402 - 2.482 GHz

5.825 - 5.850 GHz

• 802.11a/n/ac/ax 4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz

Data Rates

• 802.11b: 1, 2, 5.5, 11 Mbps

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

Technical Specifications

•	802.11a: 6,	9	12.	18.	24	36.	48.	54 N	/lbns
•	00 <u>2</u> . i ia. 0.	Ο.	14.	ıo.	4 T.	JU.	TU.	יו דע	ขเบบง

- 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
- 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz)
- 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz)

Modulation

Direct Sequence Spread Spectrum

OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM

Security³

- IEEE compliant 64 /128 bit WEP encryption for a/b/g mode only
- AES-CCMP: 128 bit in hardware
- 802.1x authentication
- WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.
- WPA2 certification
- IEEE 802.11i
- WAPI

Network Architecture

Models Roaming

Output Power⁴

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

IEEE 802.11 compliant roaming between access points

- 802.11b: +18.5dBm minimum
- 802.11g: +17.5dBm minimum
- 802.11a: +18.5dBm minimum
- 802.11n HT20(2.4GHz): +15.5dBm minimum
- 802.11n HT40(2.4GHz): +14.5dBm minimum
- 802.11n HT20(5GHz): +15.5dBm minimum
- 802.11n HT40(5GHz): +14.5dBm minimum
- 802.11ac VHT80(5GHz): +11.5dBm minimum
- 802.11ac VHT160(5GHz): +11.5dBm minimum
- 802.11ax HT40(2.4GHz): +10dBm minimum
- 802.11ax VHT160(5GHz): +10dBm minimum

Power Consumption

- Transmit mode: 2.0 W
- Receive mode:1.6 W
- Idle mode (PSP) 180 mW (WLAN Associated)
- Idle mode: 50 mW (WLAN unassociated)
- Connected Standby/Modern Standby: 10mW
- Radio disabled: 8 mW

Power Management

ACPI and PCI Express compliant power management 802.11 compliant power saving mode

Receiver Sensitivity⁵

- 802.11b, 1Mbps: -93.5dBm maximum
- 802.11b, 11Mbps: -84dBm maximum
- 802.11a/g, 6Mbps: -86dBm maximum
- 802.11a/g, 54Mbps: -72dBm maximum
- 802.11n, MCS07: -67dBm maximum
- 802.11n, MCS15: -64dBm maximum
- 802.11ac, MCS0: -84dBm maximum
- 802.11ac, MCS9: -59dBm maximum
- 802.11ax, MCS11(HT40): -59dBm maximum
- 802.11ax, MCS11(VHT160): -58.5dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the display enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Technical Specifications

Form Factor PCI-Express M.2 MiniCard with CNVi Interface

Dimensions 1. Type 2230: 2.3 x 22.0 x 30.0 mm

2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230: 2.8 g

2. Type 126: 1.3 g

3.3v +/- 9%

Operating Voltage

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

Non-operating 5% to 95% (non-condensing)

Altitude Operating 0 to 10,000 ft (3,048 m)

Non-operating 0 to 50,000 ft (15,240 m)

LED Activity

LED Amber - Radio OFF

LED Off - Radio ON

 Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs. The specifications for Wi-Fi 6 (802.11ax) are draft and are not final. If the final specifications differ from the draft specifications, it may affect the ability of the notebook to communicate with other 802.11ax devices.

- Wi-Fi supporting gigabit speeds is achievable when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 160MHz channels.
- 3. Check latest software/driver release for updates on supported security features.
- The FCC has declared as of September 1, 2014 products that utilize
 passive scanning on channel 12/13 and are capable of transmitting must
 fully comply with requirements of 15.247 or otherwise disable those
 channels.
- 5. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

HP Integrated Module with Bluetooth 4.0/4.1/4.2/5.0/5.1 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2/5.0/5.1 Compliant

Frequency Band 2402 to 2480 MHz

Number of Available Legacy: 0~79 (1 MHz/CH)

Channels BLE: 0~39 (2 MHz/CH)

Signaling Data Rate Legacy: 3 Mbps signaling data rate⁶ 2.17 Mbps

BLE: 1 Mbps signaling data rate⁶ 0.2 Mbps

6. Actual throughput may vary.

Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice

channels

Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps



asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)

Transmit Power

The Bluetooth component shall operate as a Class II Bluetooth device with a

maximum transmit power of + 9.5 dBm for BR and EDR.

Realtek Wireless LAN Standards 802.11a/b/g/n/ac (1x1) Wi-Fi® and Bluetooth® 4.2 Combo¹

IEEE 802.11a
IEEE 802.11b
IEEE 802.11g
IEEE 802.11n
IEEE 802.11ac
IEEE 802.11d
IEEE 802.11d
IEEE 802.11t
IEEE 802.11h
IEEE 802.11i
IEEE 802.11k
IEEE 802.11r

Interoperability Wi-Fi certified modules

Frequency Band

802.11b/g/n

• 2.402 - 2.482 GHz

802.11a/n/ac

IEEE 802.11v

• 4.9 - 4.95 GHz (Japan)

• 5.15 - 5.25 GHz

• 5.25 - 5.35 GHz

• 5.47 - 5.725 GHz

• 5.825 - 5.850 GHz

Data Rates

• 802.11b: 1, 2, 5.5, 11 Mbps

• 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

• 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps

802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)
 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz,

40MHz, and 80MHz)

Modulation Direct Sequence Spread Spectrum

BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM

Security²

 IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only

• AES-CCMP: 128 bit in hardware

802.1x authentication

 WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.

WPA2 certification

IEEE 802.11i

WAPI

Network Architecture

Models

Ad-hoc (Peer to Peer)

Infrastructure (Access Point Required)

Roaming

Output Power³

IEEE 802.11 compliant roaming between access points

• 802.11b: +14dBm minimum

• 802.11g: +12dBm minimum

• 802.11a: +12dBm minimum

802.11n HT20(2.4GHz): +12dBm minimum



• 802.11n HT40(2.4GHz): +12dBm minimum 802.11n HT20(5GHz): +10dBm minimum • 802.11n HT40(5GHz): +10dBm minimum 802.11ac VHT80(5GHz): +10dBm minimum

Power Consumption

• Transmit mode: 2.0 W Receive mode: 1.6 W

 Idle mode (PSP) 180 mW (WLAN Associated) Idle mode: 50 mW (WLAN unassociated)

Connected Standby/Modern Standby: 10mW

Radio disabled: 8 mW

Power Management

ACPI and PCI Express compliant power management 802.11 compliant power saving mode

Receiver Sensitivity⁴

• 802.11b, 1Mbps: -93.5dBm maximum • 802.11b, 11Mbps: -84dBm maximum 802.11a/g, 6Mbps: -86dBm maximum • 802.11a/g, 54Mbps: -72dBm maximum 802.11n, MCS07: -67dBm maximum 802.11n, MCS15: -64dBm maximum

• 802.11ac, MCS0: -84dBm maximum 802.11ac, MCS9: -59dBm maximum

Antenna type

High efficiency antenna with spatial diversity, mounted in the display

enclosure

Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications

Form Factor PCI-Express M.2 MiniCard

Dimensions Type 2230: 2.3 x 22.0 x 30.0 mm

Weight Type 2230: 2.8q **Operating Voltage** 3.3v +/- 9%

Operating **Temperature** 14° to 158° F (-10° to 70° C)

> -40° to 176° F (-40° to 80° C) **Non-operating**

Humidity Operating 10% to 90% (non-condensing)

> Non-operating 5% to 95% (non-condensing)

Altitude 0 to 10,000 ft (3,048 m) Operating

> **Non-operating** 0 to 50,000 ft (15,240 m)

LED Activity LED Amber - Radio OFF

LED Off - Radio ON

- 1. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 5 (802.11 ac) is backwards compatible with prior 802.11 specs.
- 2. Check latest software/driver release for updates on supported security features.
- 3. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.
- 4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



HP Integrated Module with Bluetooth 4.0/4.1/4.2 Wireless Technology

Bluetooth Specification 4.0/4.1/4.2 Compliant **Frequency Band** 2402 to 2480 MHz

Number of Available

Channels

Legacy: 0~79 (1 MHz/CH)BLE: 0~39 (2 MHz/CH)

Data Rates and Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Throughput

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Realtek RTL8822CE 802.11ac 2x2 Wi-Fi®+ Bluetooth® 51

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IEEE 802.11b IEEE 802.11a IEEE 802.11n

IEEE 802.11ac IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11k

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Interoperability Wi-Fi certified modules **Frequency Band**

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Roaming Output Power³ IEEE 802.11 compliant roaming between access points

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802.11n HT40(2.4GHz): +14.5dBm minimum
802.11n HT20(5GHz): +15.5dBm minimum
802.11n HT40(5GHz): +14.5dBm minimum

• 802.11ac VHT80(5GHz): +11.5dBm minimum

Power Consumption

• Transmit mode: 2.0 W

Receive mode:1.6 WIdle mode (PSP) 180 mW (WLAN Associated)

Idle mode: 50 mW (WLAN unassociated)Connected Standby/Modern Standby: 10mW

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2. Type 1216: 1.67 x 12.0 x 16.0 mm

Weight 1. Type 2230 : 2.8g

2. Type 126: 1.3g

Operating Voltage 3.3v +/- 9%

Temperature Operating 14° to 158° F (-10° to 70° C)

Non-operating -40° to 176° F (-40° to 80° C)

Humidity Operating 10% to 90% (non-condensing)

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POWER

AC Adapter 65 Watt Smart Dimensions (H x W x D) nPFC EM Barrel 4.5mm **New EM**

Weight

102x55x30mm unit: 250g +/- 10g

Input Efficiency 88.0 % at 115 Vac and 89.0 % at 230 Vac Input

> Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.7 A at 90 Vac

Output **Output power** 65W

> DC output 19.5V

Hold-up time 5ms at 115 Vac input

Output current limit <11.0A

Connector C6 (3pin/with grounded, with Smart ID DC connector) **Environmental Design** Operating 32°F to 95°F (0° to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20° to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5,000 m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%



EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class

B, CISPR22 Class B, CCC, NOM-1 NYCE.

MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 45 Watt Smart Dimensions nPFC Standard Barrel Weight 4.5mm Right Angle 1.8m

 Dimensions
 95 x 40 x 26.8 mm

 Weight
 200 g +/- 10 g

Input Input Efficiency 87.74 % at 115 Vac and 88.4 % at 230 Vac

Input frequency range 47 ~ 63 Hz

Input AC current Max. 1.4 A at 90 Vac

Output Output power 45 W

DC output 19.5 V

Hold-up time 5 ms at 115 Vac input

Output current limit <8.0A

ConnectorC6 (3pin/with grounded, with Smart ID DC connector)Environmental DesignOperating32°F to 95°F (0°to 35°C)

temperature

Non-operating (storage) -4°F to 185°F (-20°to 85°C)

temperature

Altitude 0 to 16,400 ft (0 to 5000m)

Humidity 20% to 95% **Storage Humidity** 10% to 95%

EMI and Safety Certifications CE Mark - full compliance with LVD and EMC directives

Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class

B. CISPR22 Class B. CCC. NOM-1 NYCE.

MTBF - over 200,000 hours at 25°C ambient condition.

Country of Origin

China

Options and Accessories (sold separately and availability may vary by country)

Туре	Description	Part Number
Cases	HP Prelude Pro Top Load	1X645AA
	HP Prelude Pro Backpack	1X644AA
	HP Prelude Top Load 15.6	1E7D7AA
	HP Prelude Backpack 15.6	1E7D6AA
Docking	HP USB-C®/A Universal Dock G2	5TW13AA
	HP 4.5 mm and USB-C [®] Dock Adapter G2	6LX61AA
Input/Output	HP USB Essential Keyboard/Mouse	H6L29AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Slim Wireless Keyboard & Mouse	T6L04AA
	HP Wired Desktop 320K Keyboard	9SR37AA
	HP Slim Wireless Keyboard (Link-5)	T6U20AA
	HP 3-Button USB Laser Mouse	H4B81AA
	HP Essential USB Mouse	2TX37AA
	HP USB Travel Mouse	G1K28AA
	HP Bluetooth Travel Mouse	6SP30AA
	HP Comfort Grip Wireless Mouse	H2L63AA
	HP Wired Desktop 320M Mouse	9VA80AA
	HP HDMI to VGA Adapter	H4F02AA
	HP HDMI to DVI	F5A28AA
Power	HP 45W Smart AC Adapter	H6Y88AA
	HP 65W Smart AC Adapter	H6Y89AA
	HP 65W Slim Adapters (w/ detachable DC cable + TIPS)	H6Y82AA
Storage	HP External USB Optical Drive	F2B56AA



Summary of Changes

Date of change:	Version History:	Description of change:
	V1 to V2	

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